

Certificate of Registration

HPM Technologie GmbH has achieved Registration status for HPM Power Clean to the NSF International Registration Guidelines for Proprietary Substances and Nonfood Compounds (2022) .



HPM Technologie
GmbH
Paul-Lechler-Straße 21
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Germany
June 16, 2022

Registration may be verified at
nsfwhitebook.org



A handwritten signature in black ink, appearing to read 'Orsolya Dezsi'.

Orsolya Dezsi
NSF Nonfood Compounds
Registration Program
Company No: C0538683

HPM Power Clean

Category Code: K1, K3

NSF Registration No. 166311

This product is acceptable for use as a cleaner or degreaser for use in non food processing areas (K1), which are used to remove oil, wax, resinous materials, or other substances not removable by using acidic or alkaline cleaning agents. Their use is limited to nonprocessing areas where there is no possibility of solvent vapors entering a processing area. Food processing equipment or utensils treated with such preparations must be washed with an acceptable detergent solution and thoroughly rinsed with potable water before returning to a processing area.

This product is acceptable for use as an adhesive or glue remover (K3), for removing adhesive or glue from food packaging materials in and around food processing areas, where its use is not intended for direct food contact. Before using this compound, food products and packaging materials must be removed from the area or carefully protected. After using these compounds, all surfaces must be thoroughly washed with an acceptable detergent solution, and rinsed with potable water. This compound must be used in a manner so that all odors associated with the compound are dissipated before food products or packaging materials are re-exposed in the area.

Registration of this product is current when the NSF Registration Mark and Category Code appear on the product label reviewed by NSF, and the Registered product name is in the NSF White Book™ (www.nsfwhitebook.org).

Listing of all registered nonfood compounds by NSF International is not an endorsement of those compounds or of any performance or efficacy claims made by the manufacturer.

